

	L #	Hits	Search Text	DBs	Time Stamp
1	L1	17138	plasma same microwave	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM TDB	2003/08/1 2 12:49
2	L2	84	1 and (conductive adj (polymer plastic monomer dimer oligomer) polyaniline polypyrrole polythiophene)	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM TDB	2003/08/1 2 12:50
3	L4	15510	plasma with microwave	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM TDB	2003/08/1 2 12:50
4	L5	75	4 and (conductive adj (polymer plastic monomer dimer oligomer) polyaniline polypyrrole polythiophene)	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM TDB	2003/08/1 2 12:50

*polyppyrro
polyanilin*

SNT0/0838e6 - additional/Supplemental

	L #	Hits	Search Text	DBs	Time Stamp
5	L6	0	(4 same (conductive adj (polymer plastic monomer dimer oligmer) polyaniline polypyrrole polythiophene)) not 3	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM TDB	2003/08/1 2 12:51
6	L7	73	5 not 3	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM TDB	2003/08/1 2 12:51
7	L3	2	1 same (conductive adj (polymer plastic monomer dimer oligmer) polyaniline polypyrrole polythiophene)	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM TDB	2003/08/1 2 12:51

L9 ⑨ 2 not 5-

#6 6,500,585 Sackes et al
 (D6) A 2nd ex- μ m film (D4) The metal film {Cond.
 (D7) in the 2nd step } Ray

#7 575 K, 466 Yamada et al
 (B56) The actuating gas
 (B67) Conduct the films of metal... cond. poly...

	Document ID	Issue Date	Title	Current XRef	Inventor
X P.D.M	US 5579573 A	1996120 3	Method for fabricating an undercoated chip electrically interconnected to a substrate - pursue of cold bond poly	174/259; 228/180.22; 228/254; 257/E21.50 3; 29/841; 438/118	Baker, Jay D. et al.
2	JP 5804679 5 A	1983031 8	PRODUCT ION FOR OSCILLA TING MEMBER FOR SPEAKER	29/594	AIDA, KAZUHIKO

3